

## P-Ch 60V Fast Switching MOSFETs

## Features

- Split Gate Trench MOSFET technology
- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$

## Product Summary

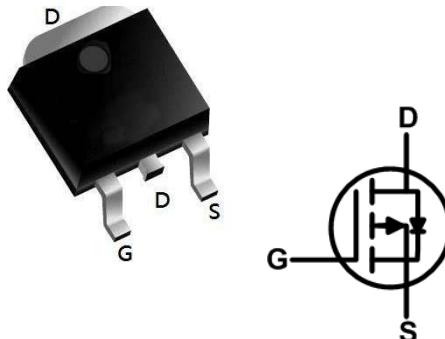


BVDSS	RDS(on)	ID
-60V	10.5mΩ	-60A

## Applications

- DC-DC Converters
- Power management functions
- Synchronous-rectification applications

## TO252-3L Pin Configuration



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
$V_{DS}$	Drain-Source Voltage	-60	V
$V_{GS}$	Gate-Source Voltage	$\pm 20$	V
$I_D @ T_C = 25^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^{1,6}$	-60	A
$I_D @ T_C = 100^\circ C$	Continuous Drain Current, $V_{GS} @ 10V^{1,6}$	-35	A
$I_{DM}$	Pulsed Drain Current <sup>2</sup>	-220	A
EAS	Single Pulse Avalanche Energy <sup>3</sup>	337	mJ
$I_{AS}$	Avalanche Current	---	A
$P_D @ T_C = 25^\circ C$	Total Power Dissipation <sup>4</sup>	100	W
$T_{STG}$	Storage Temperature Range	-55 to 150	°C
$T_J$	Operating Junction Temperature Range	-55 to 150	°C

## Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
$R_{\theta JA}$	Thermal Resistance Junction-Ambient <sup>1</sup>	---	60	°C/W
$R_{\theta JC}$	Thermal Resistance Junction-Case <sup>1</sup>	---	1.25	°C/W

Electrical Characteristics ( $T_J=25^\circ\text{C}$ , unless otherwise noted)

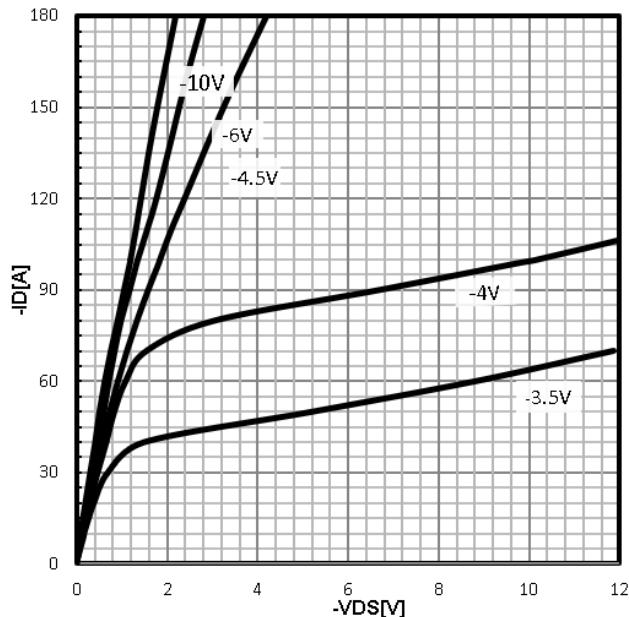
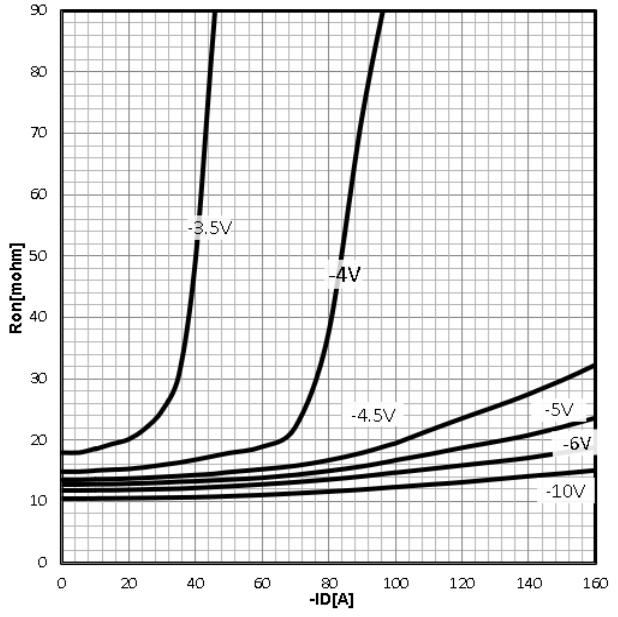
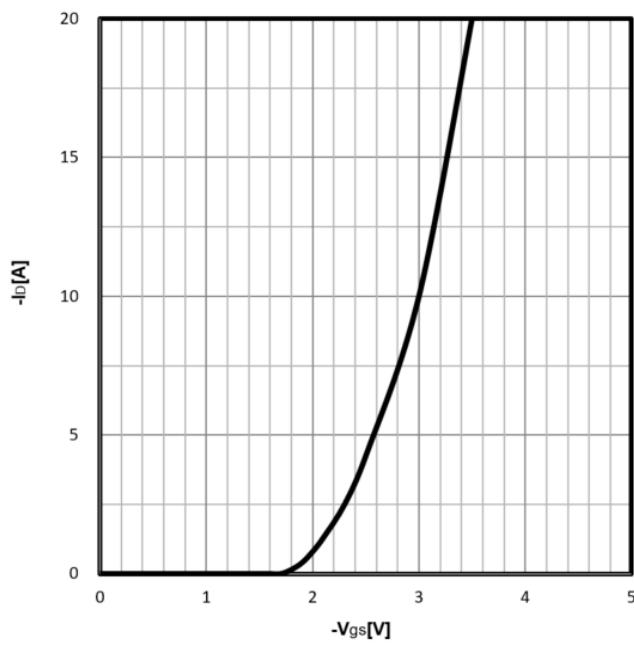
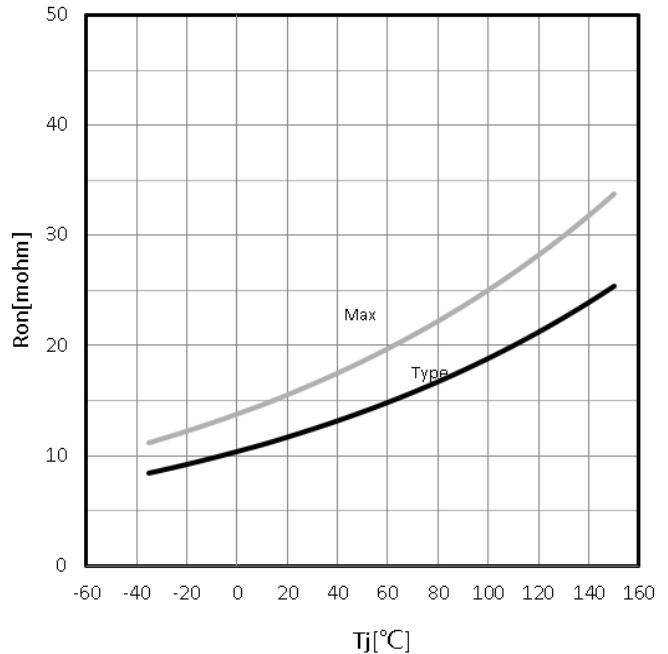
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$\text{BV}_{\text{DSS}}$	Drain-Source Breakdown Voltage	$V_{\text{GS}}=0\text{V}$ , $I_D=-250\mu\text{A}$	-60	---	---	V
$\Delta \text{BV}_{\text{DSS}}/\Delta T_J$	$\text{BV}_{\text{DSS}}$ Temperature Coefficient	Reference to $25^\circ\text{C}$ , $I_D=-1\text{mA}$	---	---	---	$\text{V}/^\circ\text{C}$
$R_{\text{DS}(\text{ON})}$	Static Drain-Source On-Resistance <sup>2</sup>	$V_{\text{GS}}=-10\text{V}$ , $I_D=-20\text{A}$	---	10.5	13.5	$\text{m}\Omega$
		$V_{\text{GS}}=-4.5\text{V}$ , $I_D=-10\text{A}$	---	13.5	17	
$V_{\text{GS}(\text{th})}$	Gate Threshold Voltage	$V_{\text{GS}}=V_{\text{DS}}$ , $I_D=-250\mu\text{A}$	-1.3	-1.8	-2.3	V
$\Delta V_{\text{GS}(\text{th})}$	$V_{\text{GS}(\text{th})}$ Temperature Coefficient		---	---	---	$\text{mV}/^\circ\text{C}$
$I_{\text{DS}(\text{SS})}$	Drain-Source Leakage Current	$V_{\text{DS}}=-60\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=25^\circ\text{C}$	---	---	-1	$\text{uA}$
		$V_{\text{DS}}=-60\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $T_J=100^\circ\text{C}$	---	---	---	
$I_{\text{GSS}}$	Gate-Source Leakage Current	$V_{\text{GS}}=\pm 20\text{V}$ , $V_{\text{DS}}=0\text{V}$	---	---	$\pm 100$	nA
$g_{\text{fs}}$	Forward Transconductance	$V_{\text{DS}}=-10\text{V}$ , $I_D=-20\text{A}$	---	48	---	S
$R_g$	Gate Resistance	$V_{\text{DS}}=0\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	12.5	---	$\Omega$
$Q_g$	Total Gate Charge	$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=-10\text{V}$ , $I_D=-10\text{A}$	---	38	---	$\text{nC}$
$Q_{\text{gs}}$	Gate-Source Charge		---	6.9	---	
$Q_{\text{gd}}$	Gate-Drain Charge		---	4.98	---	
$T_{\text{d}(\text{on})}$	Turn-On Delay Time	$V_{\text{GS}}=-10\text{V}$ , $V_{\text{DS}}=-30\text{V}$ , $I_D=-10\text{A}$ , $R_{\text{GEN}}=3\Omega$	---	20	---	$\text{ns}$
$T_r$	Rise Time		---	25	---	
$T_{\text{d}(\text{off})}$	Turn-Off Delay Time		---	60	---	
$T_f$	Fall Time		---	30	---	
$C_{\text{iss}}$	Input Capacitance	$V_{\text{DS}}=-30\text{V}$ , $V_{\text{GS}}=0\text{V}$ , $f=1\text{MHz}$	---	2630	---	$\text{pF}$
$C_{\text{oss}}$	Output Capacitance		---	484	---	
$C_{\text{rss}}$	Reverse Transfer Capacitance		---	9.4	---	

## Diode Characteristics

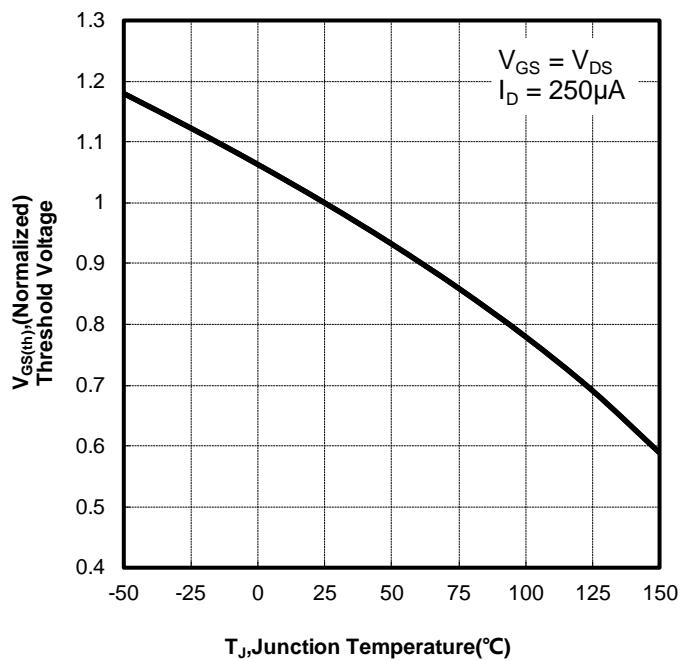
Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$I_s$	Continuous Source Current <sup>1,4</sup>	$V_G=V_D=0\text{V}$ , Force Current	---	---	-60	A
$V_{\text{SD}}$	Diode Forward Voltage <sup>2</sup>	$V_{\text{GS}}=0\text{V}$ , $I_s=-20\text{A}$ , $T_J=250^\circ\text{C}$	---	---	-1.2	V
$t_{\text{rr}}$	Reverse Recovery Time	$I_F=-20\text{A}$ , $dI/dt=100\text{A}/\mu\text{s}$ , $T_J=25^\circ\text{C}$	---	50	---	nS
$Q_{\text{rr}}$	Reverse Recovery Charge		---	80	---	nC

Notes:

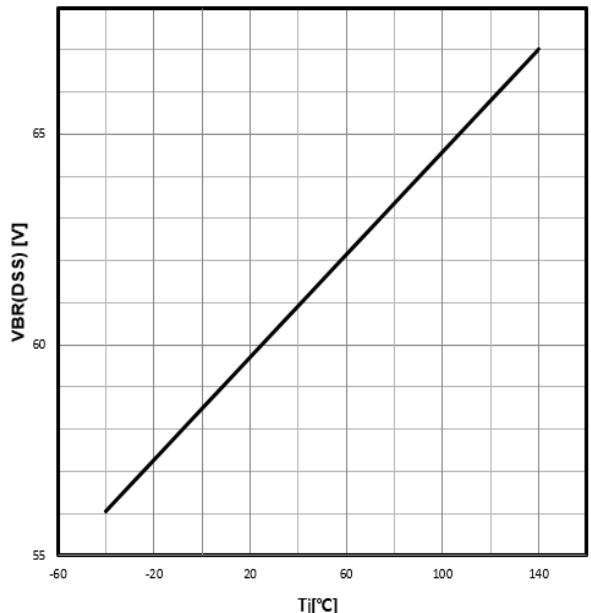
- Repetitive rating, pulse width limited by junction temperature  $T_{J(\text{MAX})}=150^\circ\text{C}$ .
- The test condition is  $V_{DD}=-25\text{V}$ ,  $V_{GS}=-10\text{V}$ ,  $L=0.4\text{mH}$ ,
- The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
- The data tested by pulsed, pulse width  $\leq 300\text{us}$ , duty cycle  $\leq 2\%$ .
- This value is guaranteed by design hence it is not included in the production test.

**Characteristics Curve:****Typ. output characteristics**  
 $-I_D = f(-V_{DS})$ **Typ. drain-source on resistance**  
 $R_{DS(on)} = f(-I_D)$ **Typ. transfer characteristics**  
 $-I_D = f(-V_{GS})$ **Drain-source on-state resistance**  
 $R_{DS(on)} = f(T_j); I_D = -20A; V_{GS} = -10V$ 

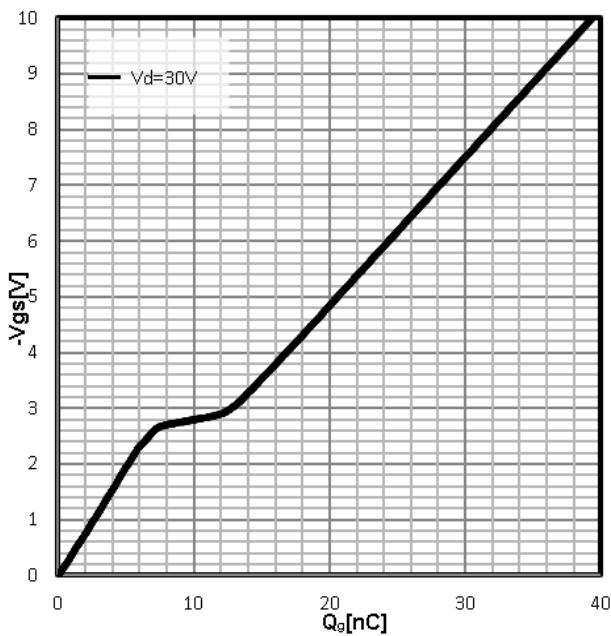
**Gate Threshold Voltage**  
 $-V_{TH} = f(T_j)$ ;  $I_D = -250\mu A$



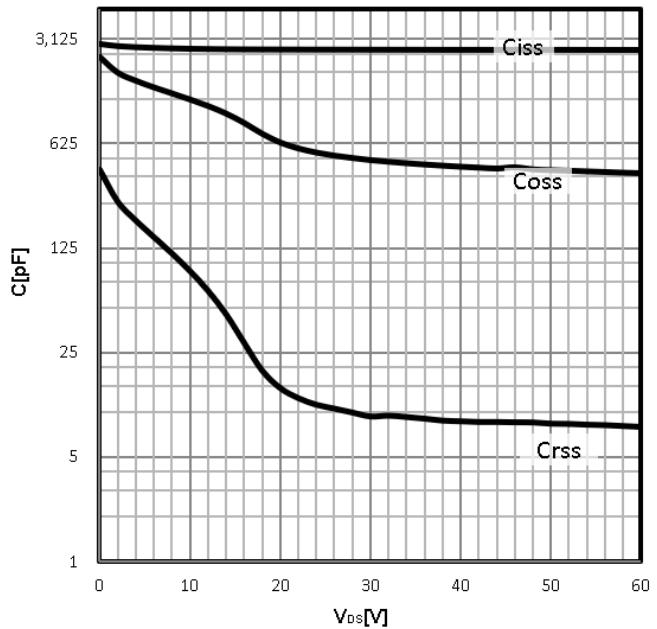
**Drain-source breakdown voltage**  
 $-V_{BR(DSS)} = f(T_j)$ ;  $I_D = -250\mu A$



**Typ. gate charge**  
 $V_{GS} = f(Q_{gate})$ ;  $I_D = -10A$

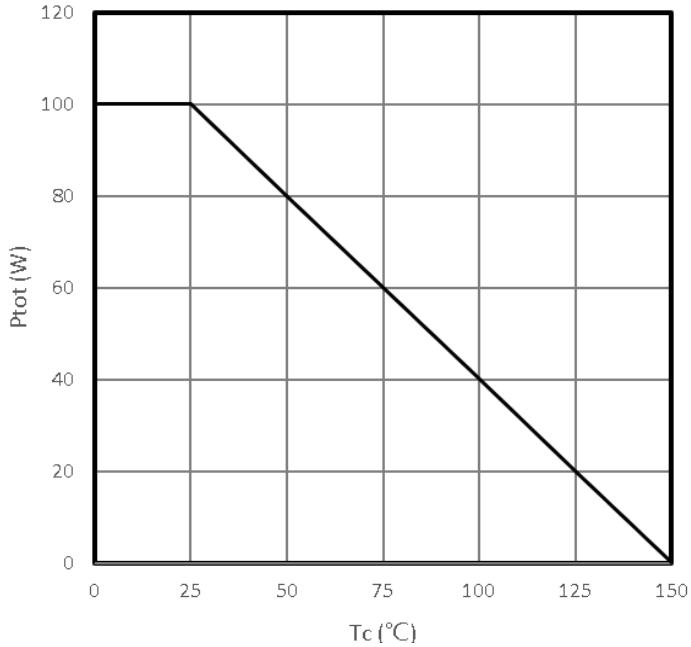


**Typ. Capacitances**  
 $C = f(-V_{DS})$ ;  $V_{GS} = 0V$ ;  $f = 1MHz$

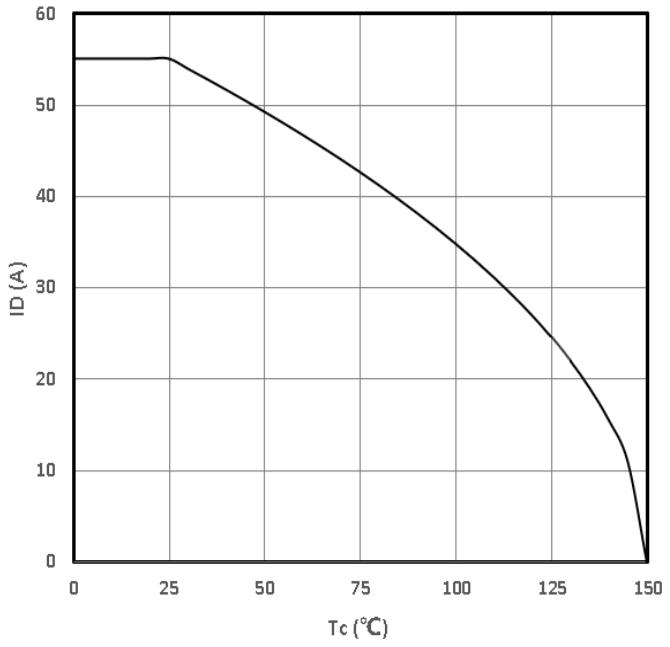


**Power Dissipation**

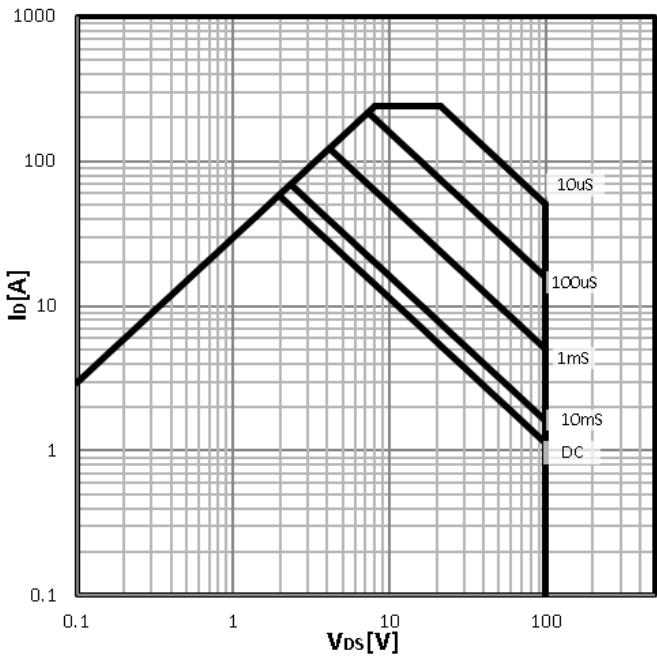
$$P_{\text{tot}} = f(T_C)$$

**Maximum Drain Current**

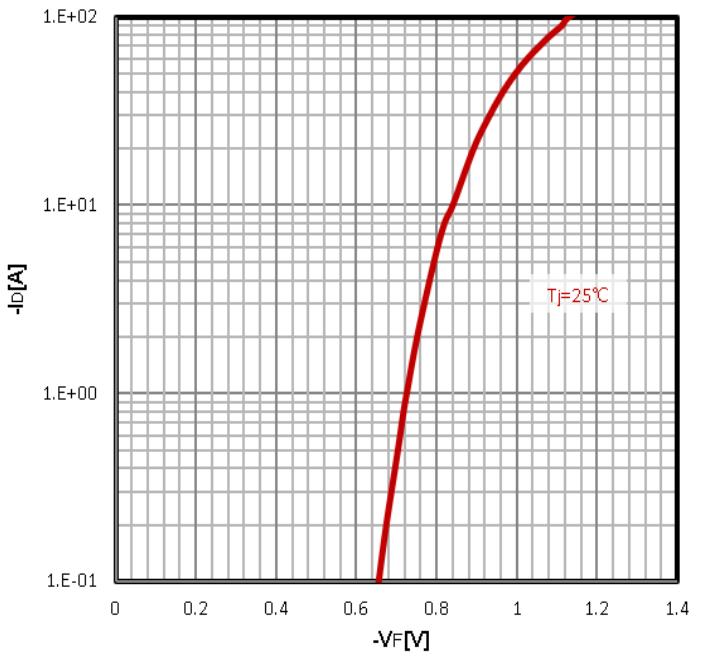
$$-I_D = f(T_C)$$

**Safe operating area**

$$-I_D = f(-V_{DS})$$

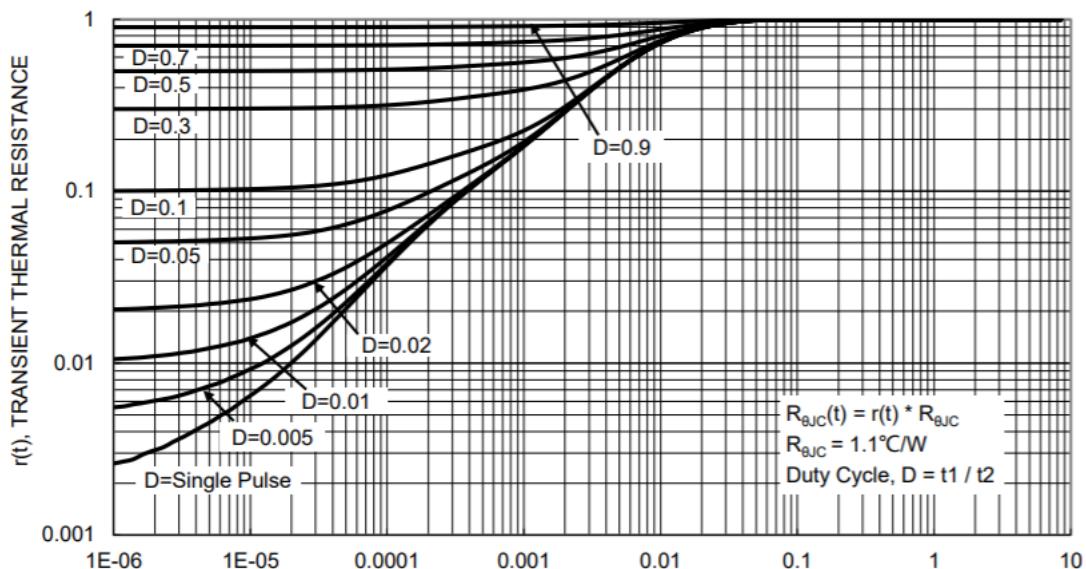
**Body Diode Forward Voltage Variation**

$$-I_F = f(-V_{DF})$$



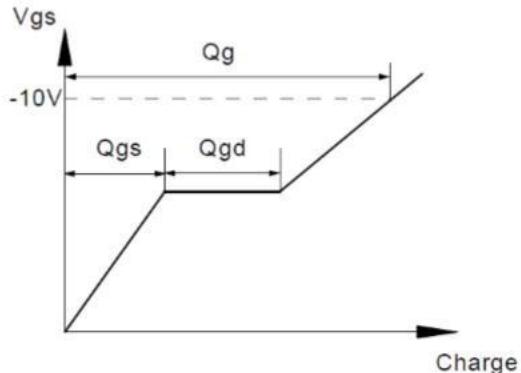
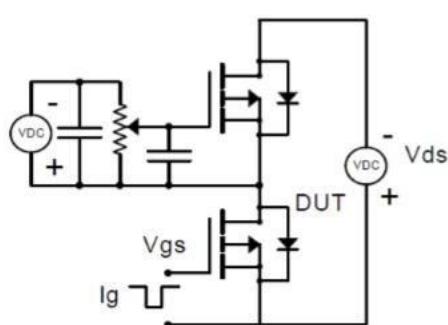
**Max. transient thermal impedance**

$$Z_{thJC} = f(t_p)$$

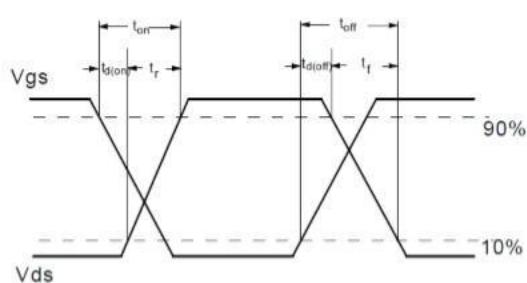
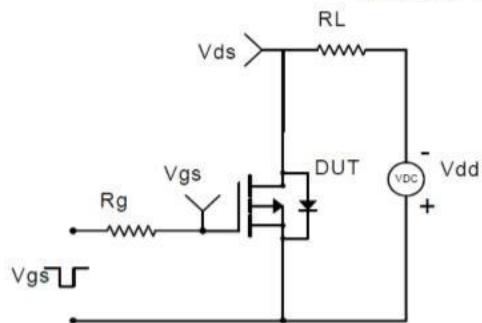


**Test Circuit and Waveform:**

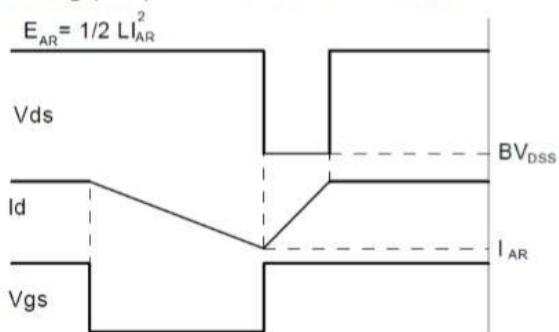
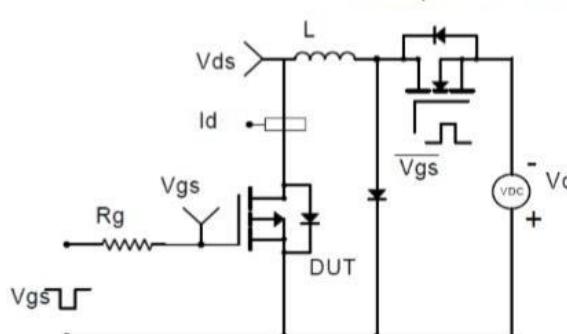
Gate Charge Test Circuit &amp; Waveform



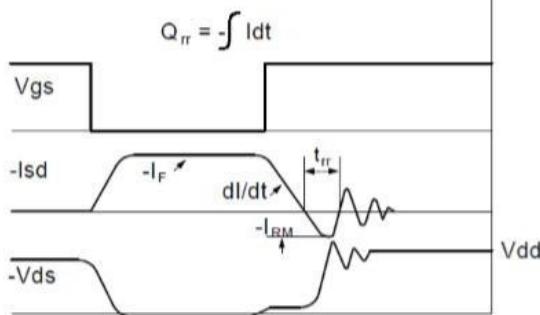
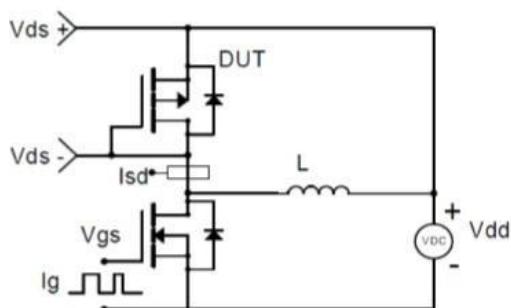
Resistive Switching Test Circuit &amp; Waveforms



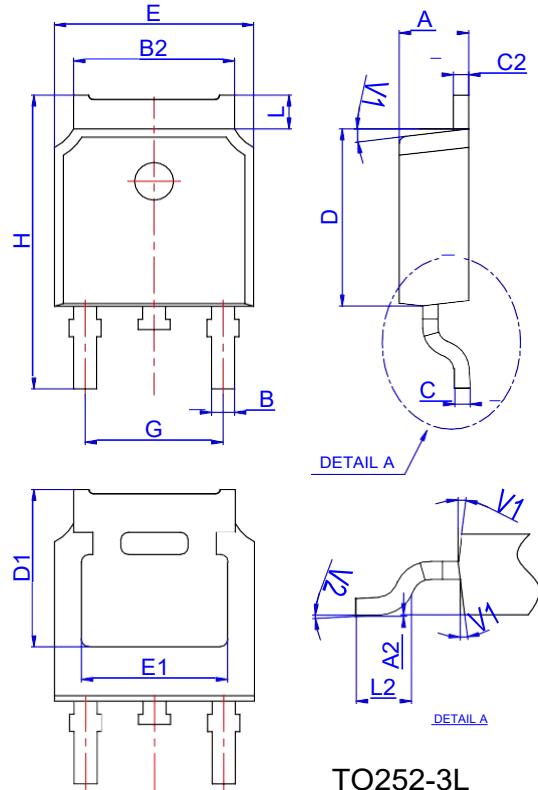
Unclamped Inductive Switching (UIS) Test Circuit &amp; Waveforms



Diode Recovery Test Circuit &amp; Waveforms



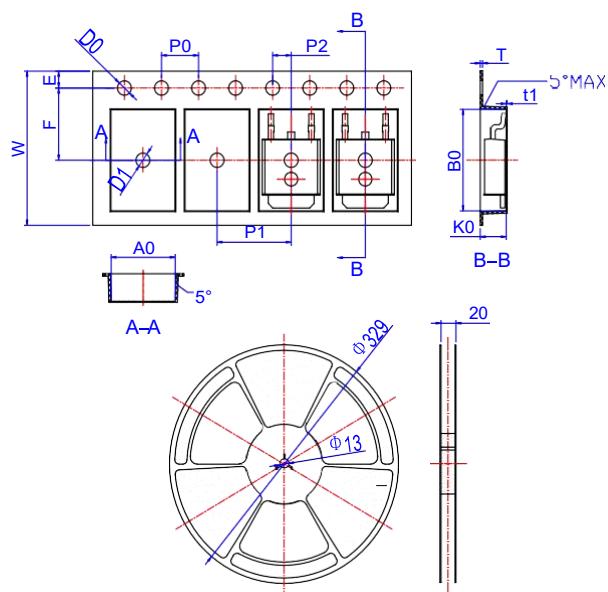
## Package Mechanical Data TO252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
B	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
C	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90		6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63			0.182		
G	4.47		4.67	0.176		0.184
H	9.50		10.70	0.374		0.421
L	1.09		1.21	0.043		0.048
L2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

TO252-3L

## Reel Specification-TO252-3L



Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
E	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
B0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
T	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583